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TID #: TIDA-00464

### TIDA-00464 REV E1 Bill of Materials



| Item # | Designator       | Quantity | Value | PartNumber        | Manufacturer | Description                                      | PackageReference         |
|--------|------------------|----------|-------|-------------------|--------------|--|--------------------------|
| 1      | PCB              | 1        |       | TIDA-00464        | Any          | Printed Circuit Board                            |                          |
| 2      | D1, D2, D3, D4   | 4        | Green | LG L29K-G2J1-24-Z | OSRAM        | LED, Green, SMD                                  | 1.7x0.65x0.8mm           |
| 3      | H1, H2, H3, H4   | 4        |       | 4826              | Keystone     | HEX STANDOFF 6-32 NYLON 1-3/4"                   | KEYSTONE 4826            |
| 4      | J1               | 1        |       | 0015910100        | Molex        | Header, 100mil, 5x2, SMT                         | Header, 100mil, 5x2, SMT |
| 5      | R1, R2, R3, R4   | 4        | 470   | CRCW0402470RJNED  | Vishay-Dale  | RES, 470, 5%, 0.063 W, 0402                      | 0402                     |
| 6      | FID1, FID2, FID3 | 0        |       | N/A               | N/A          | Fiducial mark. There is nothing to buy or mount. | Fiducial                 |

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